

This article was downloaded by:

On: 22 January 2011

Access details: *Access Details: Free Access*

Publisher *Taylor & Francis*

Informa Ltd Registered in England and Wales Registered Number: 1072954 Registered office: Mortimer House, 37-41 Mortimer Street, London W1T 3JH, UK



The Journal of Adhesion

Publication details, including instructions for authors and subscription information:

<http://www.informaworld.com/smpp/title~content=t713453635>

Editorial board page for “The Journal of Adhesion”, Volume 35, Number 1

To cite this Article (1991) 'Editorial board page for “The Journal of Adhesion”, Volume 35, Number 1', The Journal of Adhesion, 35: 1, a

To link to this Article: DOI: 10.1080/00218469108030430

URL: <http://dx.doi.org/10.1080/00218469108030430>

PLEASE SCROLL DOWN FOR ARTICLE

Full terms and conditions of use: <http://www.informaworld.com/terms-and-conditions-of-access.pdf>

This article may be used for research, teaching and private study purposes. Any substantial or systematic reproduction, re-distribution, re-selling, loan or sub-licensing, systematic supply or distribution in any form to anyone is expressly forbidden.

The publisher does not give any warranty express or implied or make any representation that the contents will be complete or accurate or up to date. The accuracy of any instructions, formulae and drug doses should be independently verified with primary sources. The publisher shall not be liable for any loss, actions, claims, proceedings, demand or costs or damages whatsoever or howsoever caused arising directly or indirectly in connection with or arising out of the use of this material.

THE JOURNAL OF ADHESION

Editor in Chief

Louis H. Sharpe, *P.O. Box 3288, Hilton Head Island, SC 29928-3288, U.S.A. [Tel: (803) 671-4810]*

Associate Editors

F. J. Boerio, *Materials Department, University of Cincinnati, Cincinnati, OH 45221, U.S.A.*

L. T. Drzal, *Center for Composite Materials and Structures, Michigan State University, East Lansing, MI 48824-1326, U.S.A.*

Takashi Igarashi, *Dept. of Biological and Chemical Engineering, Faculty of Technology, Gunma University, Kiryu, 376 Japan.*

A. J. Kinloch, *Dept. of Mechanical Engineering, Imperial College, London SW7 2BX, U.K.*

Yu. S. Lipatov, *Institute of Macromolecular Chemistry, Ukrainian Academy of Sciences, Kiev, U.S.S.R.*

C. E. M. Morris, *Materials Research Lab., Dept. of Defence, P.O. Box 50, Ascot Vale, Victoria 3032, Australia.*

J. Schultz, *C.N.R.S., 24, Avenue du President Kennedy, Mulhouse, 68200, France*

J. P. Wightman, *Center for Adhesive and Sealant Science, Virginia Polytechnic Institute and State University, Blacksburg, VA 24061-0212, U.S.A.*

Advisory Board

R. D. Adams, *University of Bristol, Bristol, U.K.*

K. W. Allen, *The City University, London, U.K.*

W. D. Bascom, *The University of Utah, Salt Lake City, U.S.A.*

D. M. Brewis, *ISST, University of Technology, Loughborough, U.K.*

W. Brockmann, *Universität Kaiserslautern, Kaiserslautern, Germany*

C. Chambu, *CECA, Levallois-Perret, France*

B. W. Cherry, *Monash University, Clayton, Australia*

H. M. Clearfield, *IBM, Yorktown Heights, U.S.A.*

A. N. Gent, *The University of Akron, Ohio, U.S.A.*

T. Hata, *Gunma University, Kiryu, Japan*

H. Ishida, *Case Western Reserve University, Cleveland, U.S.A.*

W. E. Johns, *Washington State University, Pullman, U.S.A.*

D. H. Kaelble, *Arroyo Computer Center, Thousand Oaks, U.S.A.*

L. H. Lee, *Xerox Corporation, Webster, U.S.A.*

K. Nakao, *Gifu University, Gifu, Japan*

M. Romand, *Université Claude Bernard – Lyon 1, France*

H. P. Schreiber, *École Polytechnique, Montréal, Canada*